

74AHC123A-Q100; 74AHCT123A-Q100

Dual retriggerable monostable multivibrator with reset

Rev. 1 — 23 May 2013

Product data sheet

1. General description

The 74AHC123A-Q100; 74AHCT123A-Q100 are high-speed Si-gate CMOS devices and are pin compatible with Low-power Schottky TTL (LSTTL). They are specified in compliance with JEDEC standard no. 7A.

The 74AHC123A-Q100; 74AHCT123A-Q100 are dual retriggerable monostable multivibrators with output pulse width control by three methods. The selection of an external resistor (R_{ext}) and capacitor (C_{ext}) program the basic pulse time. The external resistor and capacitor are normally connected as shown in [Figure 11](#).

Once triggered, the basic output pulse width may be extended by retriggering the gated active LOW-going edge input ($n\bar{A}$) or the active HIGH-going edge input (nB). By repeating this process, the output pulse period ($nQ = \text{HIGH}$, $n\bar{Q} = \text{LOW}$) can be made as long as desired. Alternatively an output delay can be terminated at any time by a LOW-going edge on input $n\bar{RD}$, which also inhibits the triggering.

An internal connection from $n\bar{RD}$ to the input gate makes it possible to trigger the circuit by a positive-going signal at input $n\bar{RD}$ as shown in [Table 3](#). [Figure 8](#) and [Figure 9](#) illustrate pulse control by retriggering and early reset. The values of the external timing components R_{ext} and C_{ext} , determine the basic output pulse width. When $C_{ext} \geq 10 \text{ nF}$, the typical output pulse width is defined as: $t_W = R_{ext} \times C_{ext}$ where t_W = pulse width in ns; R_{ext} = external resistor in $k\Omega$; C_{ext} = external capacitor in pF. Schmitt-trigger action at all inputs makes the circuit highly tolerant to slower input rise and fall times.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 - ◆ Specified from -40°C to $+85^\circ\text{C}$ and from -40°C to $+125^\circ\text{C}$
- All inputs have a Schmitt-trigger action
- Inputs accept voltages higher than V_{CC}
- DC triggered from active HIGH or active LOW inputs
- Retriggerable for very long pulses up to 100 % duty factor
- Direct reset terminates output pulse
- For 74AHC123A-Q100 only: operates with CMOS input levels
- For 74AHCT123A-Q100 only: operates with TTL input levels
- ESD protection:



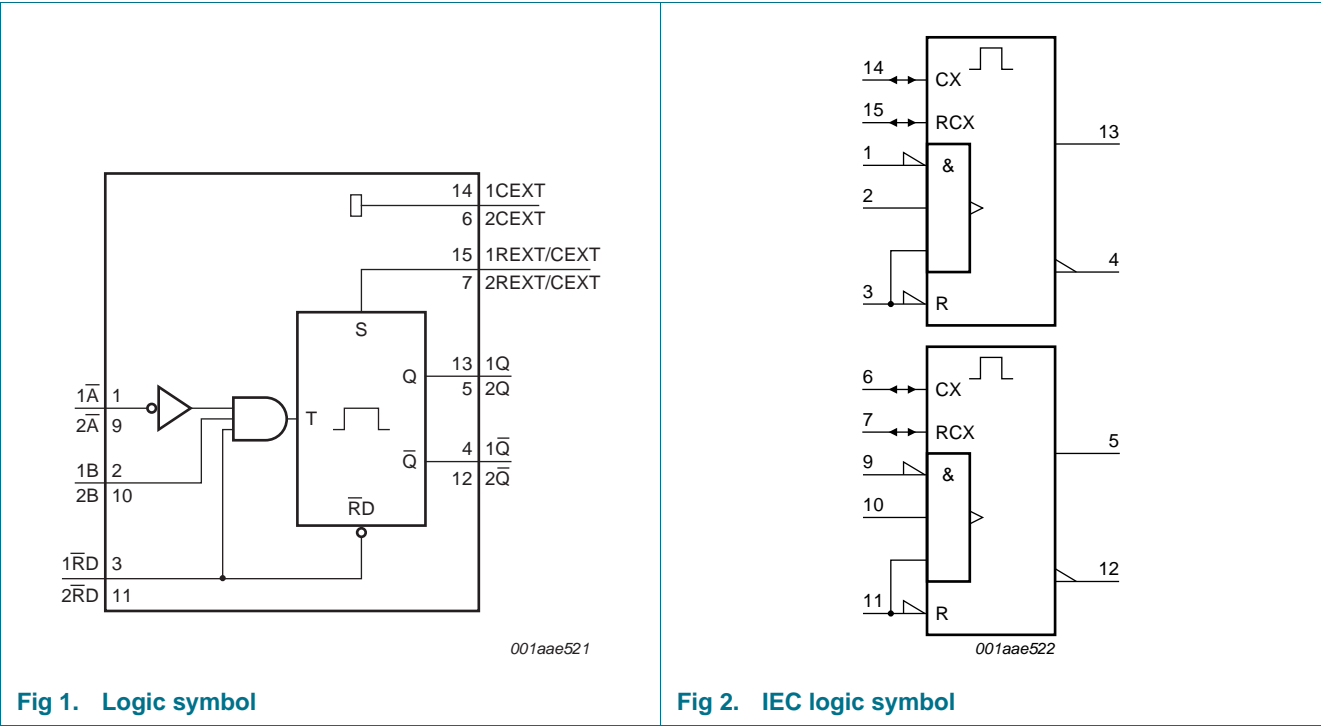
- ◆ MIL-STD-883, method 3015 exceeds 2000 V
- ◆ HBM JESD22-A114F exceeds 2000 V
- ◆ MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)
- Multiple package options

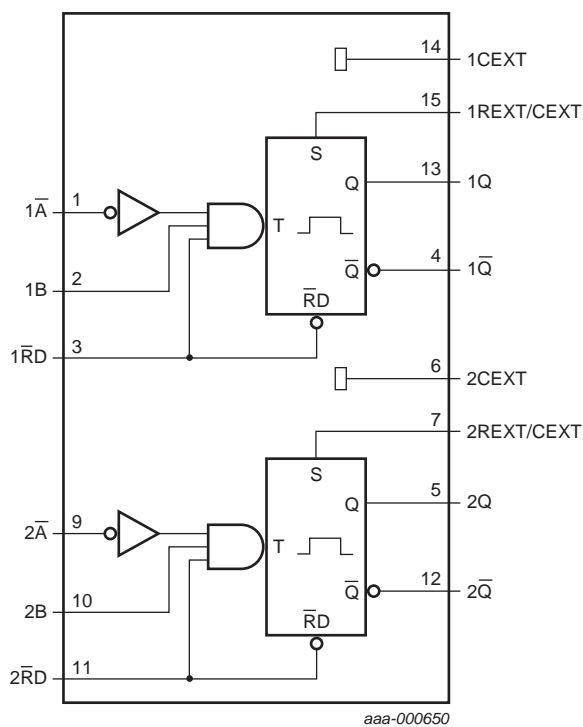
3. Ordering information

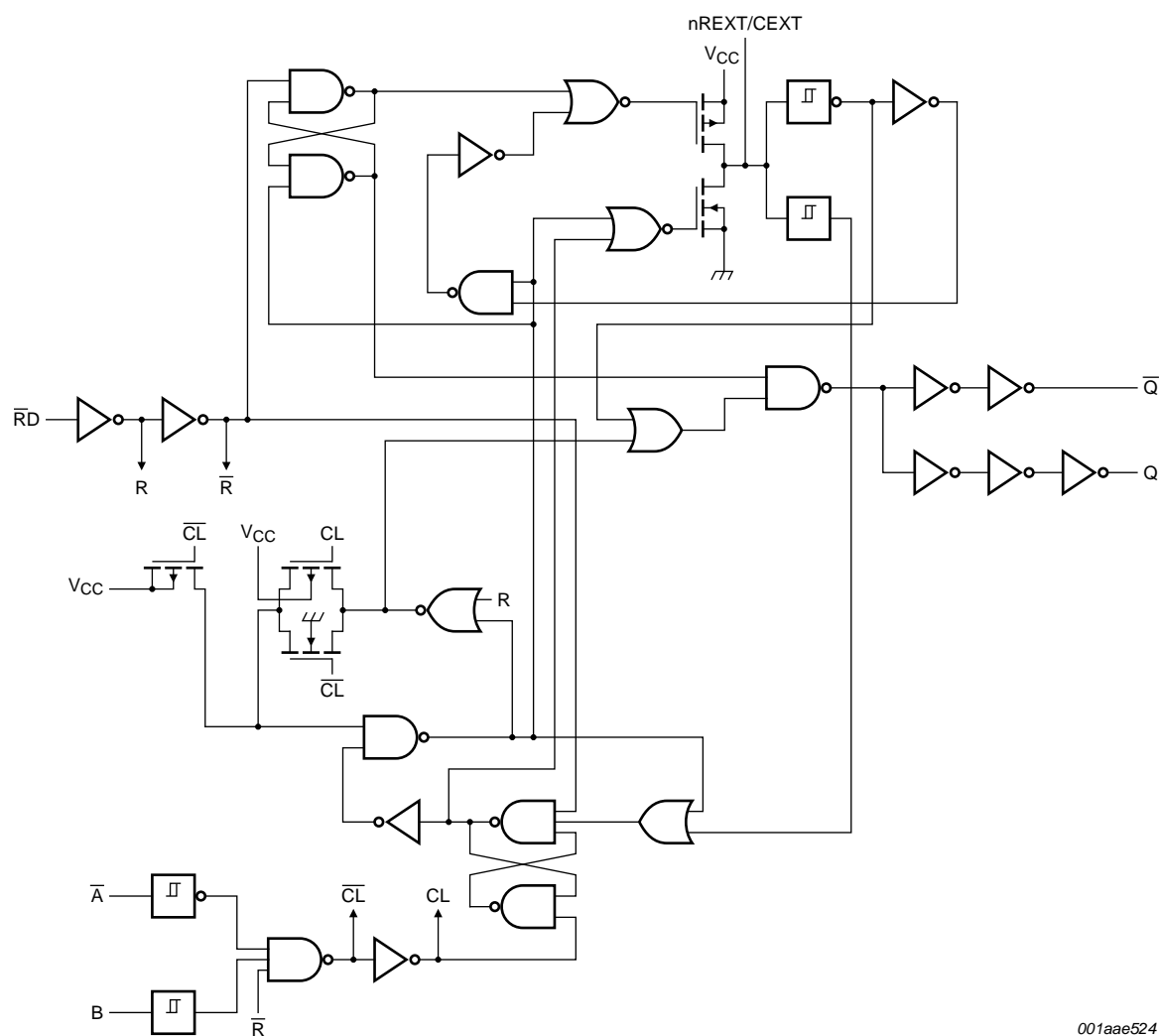
Table 1. Ordering information

| Type number | Package | | | |
|---------------------------------------|-------------------|----------|--|----------|
| | Temperature range | Name | Description | Version |
| 74AHC123AD-Q100 74AHCT123AD-Q100 | −40 °C to +125 °C | SO16 | plastic small outline package; 16 leads; body width 3.9 mm | SOT109-1 |
| 74AHC123APW-Q100 74AHCT123APW-Q100 | −40 °C to +125 °C | TSSOP16 | plastic thin shrink small outline package; 16 leads; body width 4.4 mm | SOT403-1 |
| 74AHC123ABQ-Q100 74AHCT123ABQ-Q100 | −40 °C to +125 °C | DHVQFN16 | plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 × 3.5 × 0.85 mm | SOT763-1 |

4. Functional diagram



**Fig 3. Functional diagram**



For minimum noise generation, ground pins 6 (2CEXT) and 14 (1CEXT) externally to pin 8 (GND).

Fig 4. Functional diagram

5. Pinning information

5.1 Pinning

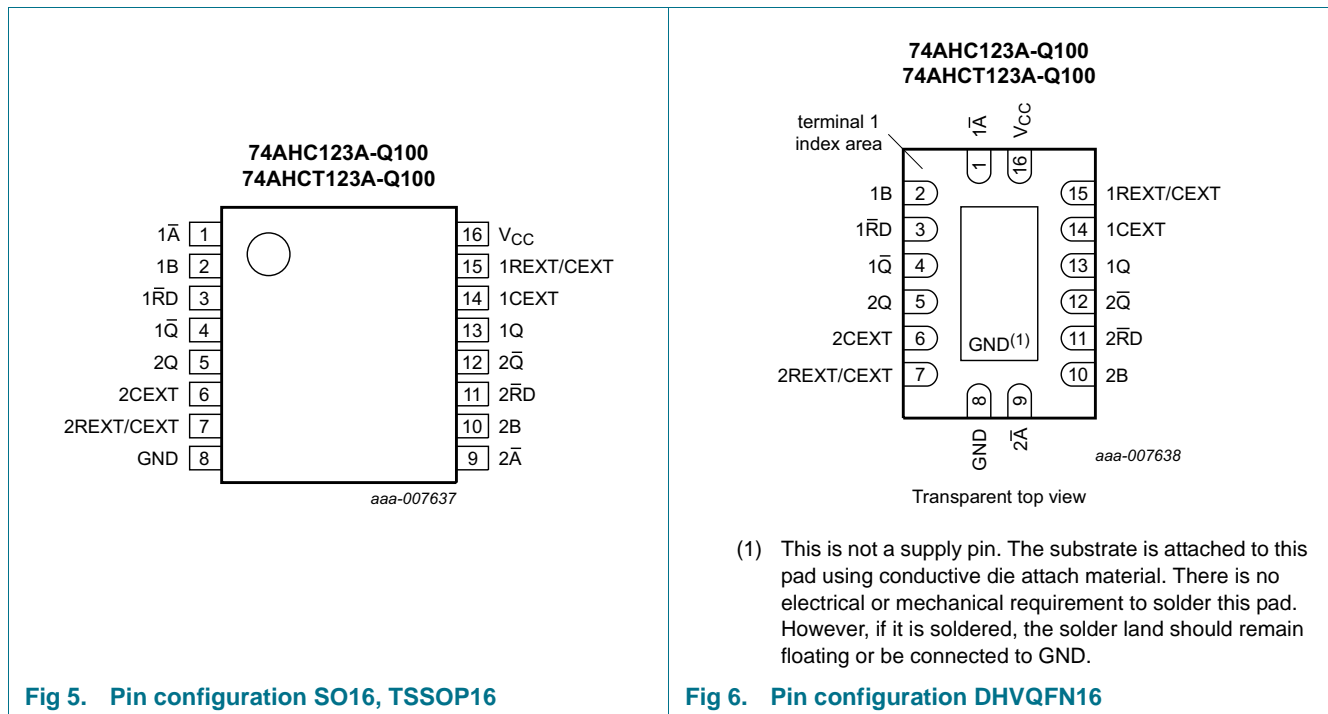


Fig 5. Pin configuration SO16, TSSOP16

Fig 6. Pin configuration DHVQFN16







5.2 Pin description

Table 2. Pin description


| Symbol | Pin | Description |
|-----------------|-----|--|
| 1 \bar{A} | 1 | negative-edge triggered input 1 |
| 1B | 2 | positive-edge triggered input 1 |
| 1 \bar{RD} | 3 | direct reset LOW and positive-edge triggered input 1 |
| 1 \bar{Q} | 4 | active LOW output 1 |
| 2Q | 5 | active HIGH output 2 |
| 2CEXT | 6 | external capacitor connection 2 |
| 2REXT/CEXT | 7 | external resistor and capacitor connection 2 |
| GND | 8 | ground (0 V) |
| 2 \bar{A} | 9 | negative-edge triggered input 2 |
| 2B | 10 | positive-edge triggered input 2 |
| 2 \bar{RD} | 11 | direct reset LOW and positive-edge triggered input 2 |
| 2 \bar{Q} | 12 | active LOW output 2 |
| 1Q | 13 | active HIGH output 1 |
| 1CEXT | 14 | external capacitor connection 1 |
| 1REXT/CEXT | 15 | external resistor and capacitor connection 1 |
| V _{CC} | 16 | supply voltage |


6. Functional description

Table 3. Function table^[1]

| Input | | | Output | |
|-------|----|----|---|---|
| nRD | nA | nB | nQ | nQ |
| L | X | X | L | H |
| X | H | X | L ^[2] | H ^[2] |
| X | X | L | L ^[2] | H ^[2] |
| H | L | ↑ |  |  |
| H | ↓ | H |  |  |
| ↑ | L | H |  |  |

- [1] H = HIGH voltage level;
 L = LOW voltage level;
 X = don't care;
 ↑ = LOW-to-HIGH transition;
 ↓ = HIGH-to-LOW transition;

 = one HIGH level output pulse;

 = one LOW level output pulse.

- [2] If the monostable multivibrator was triggered before this condition was established, the pulse continues as programmed.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------------|---|--------------------|------|------|
| V _{CC} | supply voltage | | -0.5 | +7.0 | V |
| V _I | input voltage | | -0.5 | +7.0 | V |
| I _{IK} | input clamping current | V _I < -0.5 V | ^[1] -20 | - | mA |
| I _{OK} | output clamping current | V _O < -0.5 V or V _O > V _{CC} + 0.5 V | ^[1] - | ±20 | mA |
| I _O | output current | V _O = -0.5 V to (V _{CC} + 0.5 V) | - | ±25 | mA |
| I _{CC} | supply current | | - | 75 | mA |
| I _{GND} | ground current | | -75 | - | mA |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| P _{tot} | total power dissipation | T _{amb} = -40 °C to +125 °C | | | |
| | SO16 package | | ^[2] - | 500 | mW |
| | TSSOP16 package | | ^[3] - | 500 | mW |
| | DHVQFN16 package | | ^[4] - | 500 | mW |

- [1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
 [2] P_{tot} derates linearly with 8 mW/K above 70 °C.
 [3] P_{tot} derates linearly with 5.5 mW/K above 60 °C.
 [4] P_{tot} derates linearly with 4.5 mW/K above 60 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | 74AHC123A-Q100 | | | 74AHCT123A-Q100 | | | Unit |
|---------------------|-------------------------------------|---------------------------------|----------------|-----|-----------------|-----------------|-----|-----------------|------|
| | | | Min | Typ | Max | Min | Typ | Max | |
| V _{CC} | supply voltage | | 2.0 | 5.0 | 5.5 | 4.5 | 5.0 | 5.5 | V |
| V _I | input voltage | | 0 | - | 5.5 | 0 | - | 5.5 | V |
| V _O | output voltage | | 0 | - | V _{CC} | 0 | - | V _{CC} | V |
| T _{amb} | ambient temperature | | -40 | +25 | +125 | -40 | +25 | +125 | °C |
| $\Delta t/\Delta V$ | input transition rise and fall rate | V _{CC} = 3.3 V ± 0.3 V | - | - | 100 | - | - | - | ns/V |
| | | V _{CC} = 5.0 V ± 0.5 V | - | - | 20 | - | - | 20 | ns/V |

9. Static characteristics

Table 6. Static characteristics

Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | 25 °C | | | −40 °C to +85 °C | | −40 °C to +125 °C | | Unit | |
|-----------------|---------------------------|--|-------|-----|------|------------------|------|-------------------|------|-------|----|
| | | | Min | Typ | Max | Min | Max | Min | Max | | |
| 74AHC123A-Q100 | | | | | | | | | | | |
| V _{IH} | HIGH-level input voltage | V _{CC} = 2.0 V | 1.5 | - | - | 1.5 | - | 1.5 | - | V | |
| | | V _{CC} = 3.0 V | 2.1 | - | - | 2.1 | - | 2.1 | - | V | |
| | | V _{CC} = 5.5 V | 3.85 | - | - | 3.85 | - | 3.85 | - | V | |
| V _{IL} | LOW-level input voltage | V _{CC} = 2.0 V | - | - | 0.5 | - | 0.5 | - | 0.5 | V | |
| | | V _{CC} = 3.0 V | - | - | 0.9 | - | 0.9 | - | 0.9 | V | |
| | | V _{CC} = 5.5 V | - | - | 1.65 | - | 1.65 | - | 1.65 | V | |
| V _{OH} | HIGH-level output voltage | V _I = V _{IH} or V _{IL} | | | | | | | | | |
| | | I _O = −50 μA; V _{CC} = 2.0 V | 1.9 | 2.0 | - | 1.9 | - | 1.9 | - | V | |
| | | I _O = −50 μA; V _{CC} = 3.0 V | 2.9 | 3.0 | - | 2.9 | - | 2.9 | - | V | |
| | | I _O = −50 μA; V _{CC} = 4.5 V | 4.4 | 4.5 | - | 4.4 | - | 4.4 | - | V | |
| | | I _O = −4.0 mA; V _{CC} = 3.0 V | 2.58 | - | - | 2.48 | - | 2.40 | - | V | |
| | | I _O = −8.0 mA; V _{CC} = 4.5 V | 3.94 | - | - | 3.8 | - | 3.70 | - | V | |
| V _{OL} | LOW-level output voltage | V _I = V _{IH} or V _{IL} | | | | | | | | | |
| | | I _O = 50 μA; V _{CC} = 2.0 V | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V | |
| | | I _O = 50 μA; V _{CC} = 3.0 V | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V | |
| | | I _O = 50 μA; V _{CC} = 4.5 V | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V | |
| | | I _O = 4.0 mA; V _{CC} = 3.0 V | - | - | 0.36 | - | 0.44 | - | 0.55 | V | |
| | | I _O = 8.0 mA; V _{CC} = 4.5 V | - | - | 0.36 | - | 0.44 | - | 0.55 | V | |
| I _I | input leakage current | V _I = 5.5 V or GND; V _{CC} = 0 V to 5.5 V | | | | | | | | | |
| | | nREXT/CEXT | [1] | - | - | ±0.25 | - | ±2.5 | - | ±10.0 | μA |
| | | pins nA, nB, nRD | | - | - | ±0.1 | - | ±1.0 | - | ±2.0 | μA |

Table 6. Static characteristics ...continued
 Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | 25 °C | | | –40 °C to +85 °C | | –40 °C to +125 °C | | Unit |
|------------------------|---------------------------|---|-------|-----|------------|------------------|-----------|-------------------|------------|---------|
| | | | Min | Typ | Max | Min | Max | Min | Max | |
| I_{CC} | supply current | $V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5$ V | - | - | 4.0 | - | 40 | - | 80 | μ A |
| | | active state (per circuit); $V_I = V_{CC}$ or GND | | | | | | | | |
| | | $V_{CC} = 3.0$ V | - | 160 | 250 | - | 280 | - | 280 | μ A |
| | | $V_{CC} = 4.5$ V | - | 380 | 500 | - | 650 | - | 650 | μ A |
| | | $V_{CC} = 5.5$ V | - | 560 | 750 | - | 975 | - | 975 | μ A |
| C_I | input capacitance | | - | 5.0 | 10 | - | 10 | - | 10 | pF |
| C_O | output capacitance | | - | 4.0 | - | - | - | - | - | pF |
| 74AHCT123A-Q100 | | | | | | | | | | |
| V_{IH} | HIGH-level input voltage | $V_{CC} = 4.5$ V to 5.5 V | 2.0 | - | - | 2.0 | - | 2.0 | - | V |
| V_{IL} | LOW-level input voltage | $V_{CC} = 4.5$ V to 5.5 V | - | - | 0.8 | - | 0.8 | - | 0.8 | V |
| V_{OH} | HIGH-level output voltage | $V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 4.5$ V | | | | | | | | |
| | | $I_O = -50$ μ A | 4.4 | 4.5 | - | 4.4 | - | 4.4 | - | V |
| | | $I_O = -8.0$ mA | 3.94 | - | - | 3.8 | - | 3.70 | - | V |
| V_{OL} | LOW-level output voltage | $V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 4.5$ V | | | | | | | | |
| | | $I_O = 50$ μ A | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | $I_O = 8.0$ mA | - | - | 0.36 | - | 0.44 | - | 0.55 | V |
| I_I | input leakage current | nREXT/CEXT; $V_I = 5.5$ V or GND; $V_{CC} = 0$ V to 5.5 V | [1] | - | ± 0.25 | - | ± 2.5 | - | ± 10.0 | μ A |
| | | pins nA, nB, nRD; $V_I = V_{CC}$ or GND; $V_{CC} = 5.5$ V | - | - | ± 0.1 | - | ± 1.0 | - | ± 2.0 | μ A |
| I_{CC} | supply current | $V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5$ V | - | - | 4.0 | - | 40 | - | 80 | μ A |
| | | active state (per circuit); $V_I = V_{CC}$ or GND | | | | | | | | |
| | | $V_{CC} = 4.5$ V | - | 380 | 500 | - | 650 | - | 650 | μ A |
| | | $V_{CC} = 5.5$ V | - | 560 | 750 | - | 975 | - | 975 | μ A |
| C_I | input capacitance | | - | 3 | 10 | - | 10 | - | 10 | pF |
| C_O | output capacitance | | - | 4.0 | - | - | - | - | - | pF |

[1] Voltage on nREXT/CEXT = $0.5 \times V_{CC}$ and pin nREXT/CEXT in OFF-state during test.

10. Dynamic characteristics

Table 7. Dynamic characteristics

$GND = 0\text{ V}$; For test circuit see [Figure 12](#).

| Symbol | Parameter | Conditions | 25 °C | | | −40 °C to +85 °C | | −40 °C to +125 °C | | Unit |
|-----------------|-------------------|---|-------|--------------------|------|------------------|------|-------------------|------|------|
| | | | Min | Typ ^[1] | Max | Min | Max | Min | Max | |
| 74AHC123A-Q100 | | | | | | | | | | |
| t _{pd} | propagation delay | n \overline{A} and nB to nQ and n \overline{Q} ; see Figure 7 ^[2] | | | | | | | | |
| | | V _{CC} = 3.0 V to 3.6 V | | | | | | | | |
| | | C _L = 15 pF | - | 7.4 | 20.6 | 1.0 | 24.0 | 1.0 | 26.0 | ns |
| | | C _L = 50 pF | - | 10.5 | 24.1 | 1.0 | 27.5 | 1.0 | 30.0 | ns |
| | | V _{CC} = 4.5 V to 5.5 V | | | | | | | | |
| | | C _L = 15 pF | - | 5.1 | 12.0 | 1.0 | 14.0 | 1.0 | 15.5 | ns |
| | | C _L = 50 pF | - | 7.3 | 14.0 | 1.0 | 16.0 | 1.0 | 17.5 | ns |
| | | n \overline{RD} to nQ and n \overline{Q} ; see Figure 7 ^[2] | | | | | | | | |
| | | V _{CC} = 3.0 V to 3.6 V | | | | | | | | |
| | | C _L = 15 pF | - | 8.2 | 22.4 | 1.0 | 26.0 | 1.0 | 28.0 | ns |
| | | C _L = 50 pF | - | 11.7 | 25.9 | 1.0 | 29.5 | 1.0 | 32.0 | ns |
| | | V _{CC} = 4.5 V to 5.5 V | | | | | | | | |
| | | C _L = 15 pF | - | 5.6 | 12.9 | 1.0 | 15.0 | 1.0 | 16.5 | ns |
| | | C _L = 50 pF | - | 8.1 | 14.9 | 1.0 | 17.0 | 1.0 | 19.0 | ns |
| | | n \overline{RD} to nQ and n \overline{Q} (reset); see Figure 7 ^[2] | | | | | | | | |
| | | V _{CC} = 3.0 V to 3.6 V | | | | | | | | |
| | | C _L = 15 pF | - | 6.4 | 15.8 | 1.0 | 18.5 | 1.0 | 20.0 | ns |
| | | C _L = 50 pF | - | 9.2 | 19.3 | 1.0 | 22.0 | 1.0 | 24.5 | ns |
| | | V _{CC} = 4.5 V to 5.5 V | | | | | | | | |
| | | C _L = 15 pF | - | 4.4 | 9.4 | 1.0 | 11.0 | 1.0 | 12.0 | ns |
| | | C _L = 50 pF | - | 6.3 | 11.4 | 1.0 | 13.0 | 1.0 | 14.5 | ns |

Table 7. Dynamic characteristics ...continuedGND = 0 V; For test circuit see [Figure 12](#).

| Symbol | Parameter | Conditions | 25 °C | | | –40 °C to +85 °C | | –40 °C to +125 °C | | Unit |
|-------------|-------------------------------|--|----------------|--------------------|-----|------------------|-----|-------------------|------|---------|
| | | | Min | Typ ^[1] | Max | Min | Max | Min | Max | |
| t_W | pulse width | inputs; \overline{nA} = LOW; see Figure 7 | | | | | | | | |
| | | V_{CC} = 3.0 V to 3.6 V | 5.0 | - | - | 5.0 | - | 5.0 | - | ns |
| | | V_{CC} = 4.5 V to 5.5 V | 5.0 | - | - | 5.0 | - | 5.0 | - | ns |
| | | inputs; nB = HIGH; see Figure 7 | | | | | | | | |
| | | V_{CC} = 3.0 V to 3.6 V | 5.0 | - | - | 5.0 | - | 5.0 | - | ns |
| | | V_{CC} = 4.5 V to 5.5 V | 5.0 | - | - | 5.0 | - | 5.0 | - | ns |
| | | inputs; \overline{nRD} = LOW; see Figure 7 | | | | | | | | |
| | | V_{CC} = 3.0 V to 3.6 V | 5.0 | - | - | 5.0 | - | 5.0 | - | ns |
| | | V_{CC} = 4.5 V to 5.5 V | 5.0 | - | - | 5.0 | - | 5.0 | - | ns |
| | | outputs; \overline{nQ} = LOW and nQ = HIGH; C_L = 50 pF; see Figure 7 , Figure 8 , Figure 9 and Figure 10 | | | | | | | | |
| | | C_{ext} = 28 pF; R_{ext} = 2 k Ω | | | | | | | | |
| | | V_{CC} = 3.0 V to 3.6 V | - | 115 | 240 | - | 300 | - | 300 | ns |
| | | V_{CC} = 4.5 V to 5.5 V | - | 100 | 200 | - | 240 | - | 240 | ns |
| | | C_{ext} = 0.01 μ F; R_{ext} = 10 k Ω | | | | | | | | |
| | | V_{CC} = 3.0 V to 3.6 V | 90 | 100 | 110 | 90 | 110 | 85 | 115 | μ s |
| | | V_{CC} = 4.5 V to 5.5 V | 90 | 100 | 110 | 90 | 110 | 85 | 115 | μ s |
| | | C_{ext} = 0.1 μ F; R_{ext} = 10 k Ω ; | | | | | | | | |
| | | V_{CC} = 3.0 V to 3.6 V | 0.9 | 1 | 1.1 | 0.9 | 1.1 | 0.85 | 1.15 | ms |
| | | V_{CC} = 4.5 V to 5.5 V | 0.9 | 1 | 1.1 | 0.9 | 1.1 | 0.85 | 1.15 | ms |
| t_{rtrig} | retrigger time | \overline{nA} to nB ; C_{ext} = 100 pF; R_{ext} = 1 k Ω ; C_L = 50 pF; see Figure 8 and Figure 10 | | | | | | | | |
| | | V_{CC} = 3.0 V to 3.6 V | - | 60 | - | - | - | - | - | ns |
| | | V_{CC} = 4.5 V to 5.5 V | - | 39 | - | - | - | - | - | ns |
| | | \overline{nA} to nB ; C_{ext} = 0.01 μ F; R_{ext} = 1 k Ω ; C_L = 50 pF; see Figure 8 and Figure 10 | | | | | | | | |
| | | V_{CC} = 3.0 V to 3.6 V | - | 1.5 | - | - | - | - | - | μ s |
| | | V_{CC} = 4.5 V to 5.5 V | - | 1.2 | - | - | - | - | - | μ s |
| C_{PD} | power dissipation capacitance | C_L = 50 pF; f_i = 1 MHz; V_i = GND to V_{CC} | ^[4] | 57 | - | - | - | - | - | pF |

Table 7. Dynamic characteristics ...continued

GND = 0 V; For test circuit see [Figure 12](#).

| Symbol | Parameter | Conditions | 25 °C | | | −40 °C to +85 °C | | −40 °C to +125 °C | | Unit |
|-----------------|-------------------|---|-------|--------------------|------|------------------|------|-------------------|------|---------|
| | | | Min | Typ ^[1] | Max | Min | Max | Min | Max | |
| 74AHCT123A-Q100 | | | | | | | | | | |
| t _{pd} | propagation delay | n \overline{A} and nB to nQ and n \overline{Q} ; see Figure 7 [2] | | | | | | | | |
| | | V _{CC} = 4.5 V to 5.5 V | | | | | | | | |
| | | C _L = 15 pF | - | 5.0 | 12.0 | 1.0 | 14.0 | 1.0 | 15.5 | ns |
| | | C _L = 50 pF | - | 7.1 | 14.0 | 1.0 | 16.0 | 1.0 | 17.5 | ns |
| | | n \overline{RD} to nQ and n \overline{Q} ; see Figure 7 [2] | | | | | | | | |
| | | V _{CC} = 4.5 V to 5.5 V | | | | | | | | |
| | | C _L = 15 pF | - | 5.2 | 12.9 | 1.0 | 15.0 | 1.0 | 16.5 | ns |
| | | C _L = 50 pF | - | 7.5 | 14.9 | 1.0 | 17.0 | 1.0 | 18.5 | ns |
| | | n \overline{RD} to nQ and n \overline{Q} (reset); see Figure 7 [2] | | | | | | | | |
| | | V _{CC} = 4.5 V to 5.5 V | | | | | | | | |
| | | C _L = 15 pF | - | 4.7 | 9.4 | 1.0 | 11.0 | 1.0 | 12.0 | ns |
| | | C _L = 50 pF | - | 6.7 | 11.4 | 1.0 | 13.0 | 1.0 | 14.5 | ns |
| t _W | pulse width | inputs; n \overline{A} = LOW; C _L = 50 pF; see Figure 7 | | | | | | | | |
| | | V _{CC} = 4.5 V to 5.5 V | 5.0 | - | - | 5.0 | - | 5.0 | - | ns |
| | | inputs; nB = HIGH; C _L = 50 pF; see Figure 7 | | | | | | | | |
| | | V _{CC} = 4.5 V to 5.5 V | 5.0 | - | - | 5.0 | - | 5.0 | - | ns |
| | | inputs; n \overline{RD} = LOW; C _L = 50 pF; see Figure 7 | | | | | | | | |
| | | V _{CC} = 4.5 V to 5.5 V | 5.0 | - | - | 5.0 | - | 5.0 | - | ns |
| | | outputs; n \overline{Q} = LOW and nQ = HIGH; C _L = 50 pF; C _{ext} = 28 pF; R _{ext} = 2 k Ω ; see Figure 7 , Figure 8 , Figure 9 and Figure 10 [3] | | | | | | | | |
| | | V _{CC} = 4.5 V to 5.5 V | - | 100 | 200 | - | 240 | - | 240 | ns |
| | | C _{ext} = 0.01 μ F; R _{ext} = 10 k Ω | | | | | | | | |
| | | V _{CC} = 4.5 V to 5.5 V | 90 | 100 | 110 | 90 | 110 | 85 | 115 | μ s |
| | | C _{ext} = 0.1 μ F; R _{ext} = 10 k Ω | | | | | | | | |
| | | V _{CC} = 4.5 V to 5.5 V | 0.9 | 1 | 1.1 | 0.9 | 1.1 | 0.85 | 1.15 | ms |

Table 7. Dynamic characteristics ...continuedGND = 0 V; For test circuit see [Figure 12](#).

| Symbol | Parameter | Conditions | 25 °C | | | –40 °C to +85 °C | | –40 °C to +125 °C | | Unit |
|-------------------|-------------------------------|---|---------------------|--------------------|-----|------------------|-----|-------------------|-----|------|
| | | | Min | Typ ^[1] | Max | Min | Max | Min | Max | |
| t _{trig} | retrigger time | nA to nB; C _{ext} = 100 pF; R _{ext} = 1 kΩ; C _L = 50 pF; see Figure 8 and Figure 10 | | | | | | | | |
| | | V _{CC} = 4.5 V to 5.5 V | - | 60 | - | - | - | - | - | ns |
| | | nA to nB; C _{ext} = 0.01 μF; R _{ext} = 1 kΩ; C _L = 50 pF; see Figure 8 and Figure 10 | | | | | | | | |
| | | V _{CC} = 4.5 V to 5.5 V | - | 1.5 | - | - | - | - | - | μs |
| C _{PD} | power dissipation capacitance | C _L = 50 pF; f _i = 1 MHz; V _i = GND to V _{CC} | [4] | 58 | - | - | - | - | - | pF |

External components

| | | | | | | | | | | |
|------------------|----------------------|-------------------------|---------------------|---|---|---|---|---|---|----|
| R _{ext} | external resistance | V _{CC} = 2.0 V | 5 | - | - | - | - | - | - | kΩ |
| | | V _{CC} > 3.0 V | 1 | - | - | - | - | - | - | kΩ |
| C _{ext} | external capacitance | V _{CC} = 2.0 V | [5] | - | - | - | - | - | - | pF |
| | | V _{CC} > 3.0 V | [5] | - | - | - | - | - | - | pF |

[1] Typical values are measured at nominal supply voltage (V_{CC} = 3.3 V and V_{CC} = 5.0 V).[2] t_{pd} is the same as t_{PLH} and t_{PHL}; C_{ext} = 0 pF; R_{ext} = 5 kΩ.[3] For C_{ext} ≥ 10 nF, the typical value of the pulse width t_W (μs) = C_{ext} (nF) × R_{ext} (kΩ).[4] C_{PD} is used to determine the dynamic power dissipation P_D (μW).P_D = C_{PD} × V_{CC}² × f_i + Σ(C_L × V_{CC}² × f_o) where:f_i = input frequency in MHz;f_o = output frequency in MHz;C_L = output load capacitance in pF;V_{CC} = supply voltage in V.[5] C_{ext} has no limits.

11. Waveforms

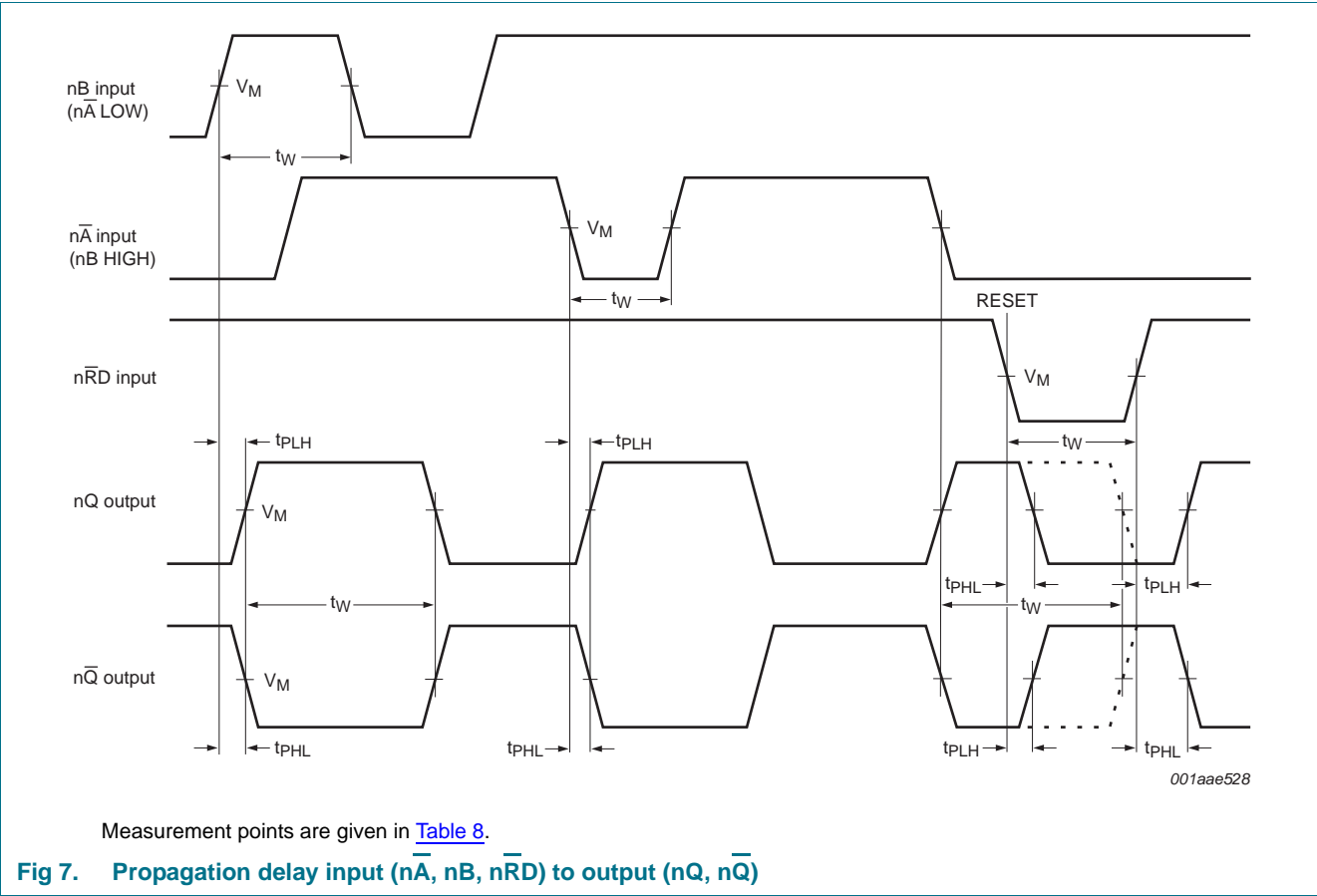
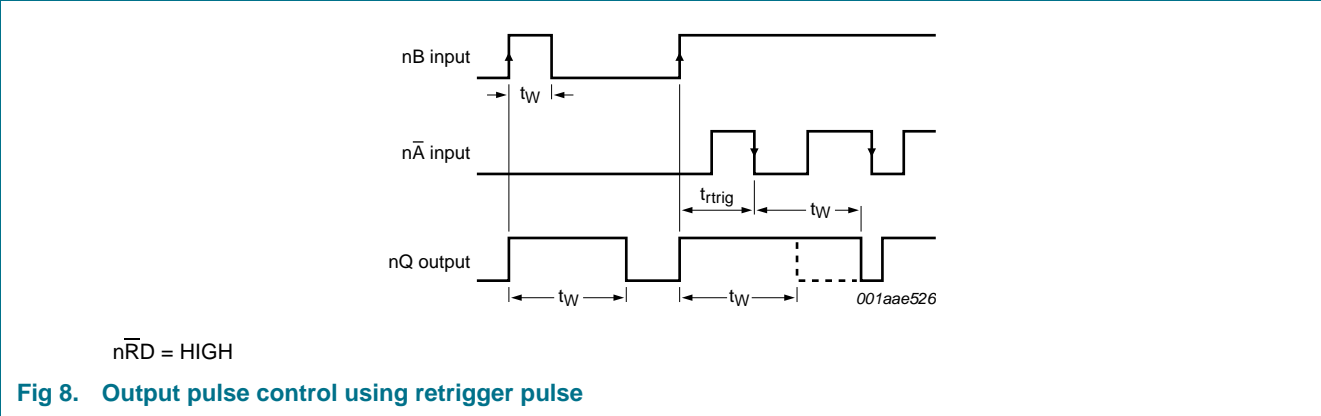
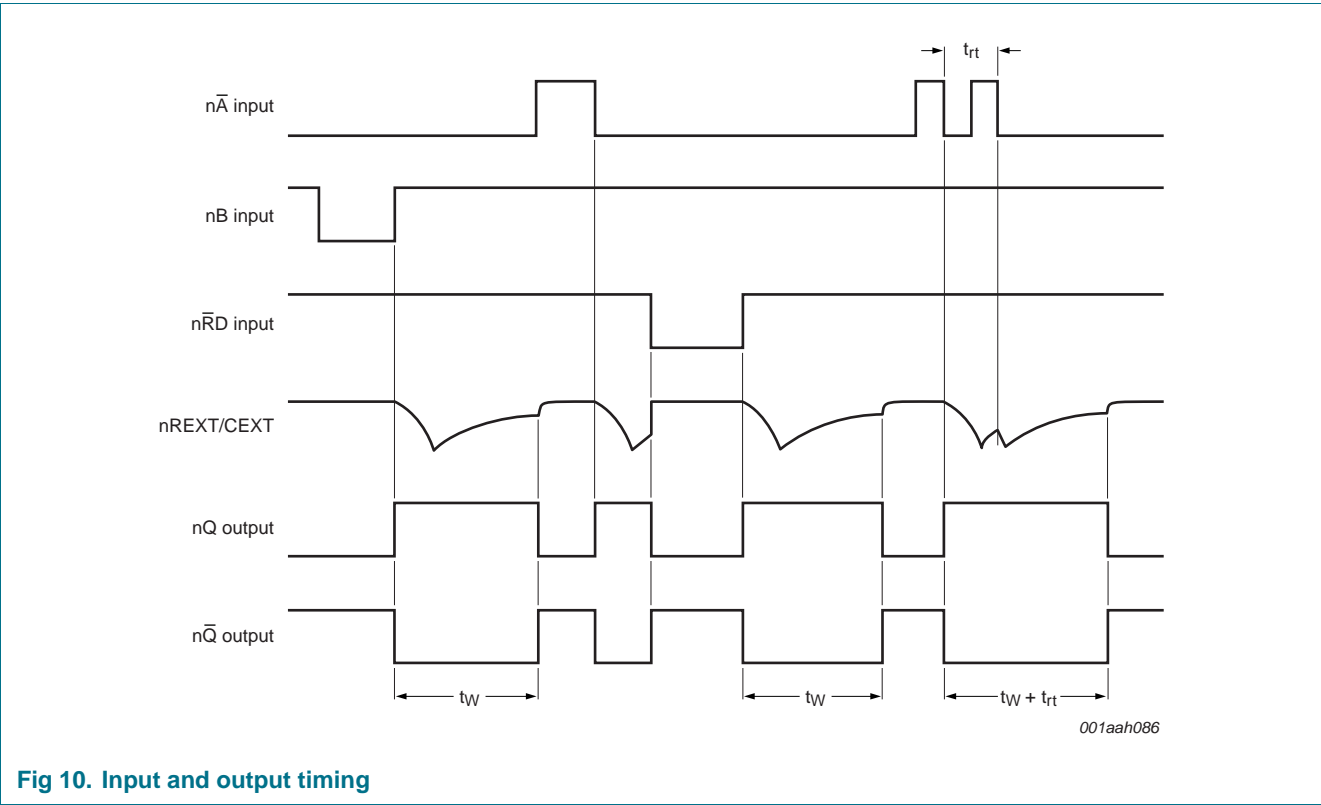
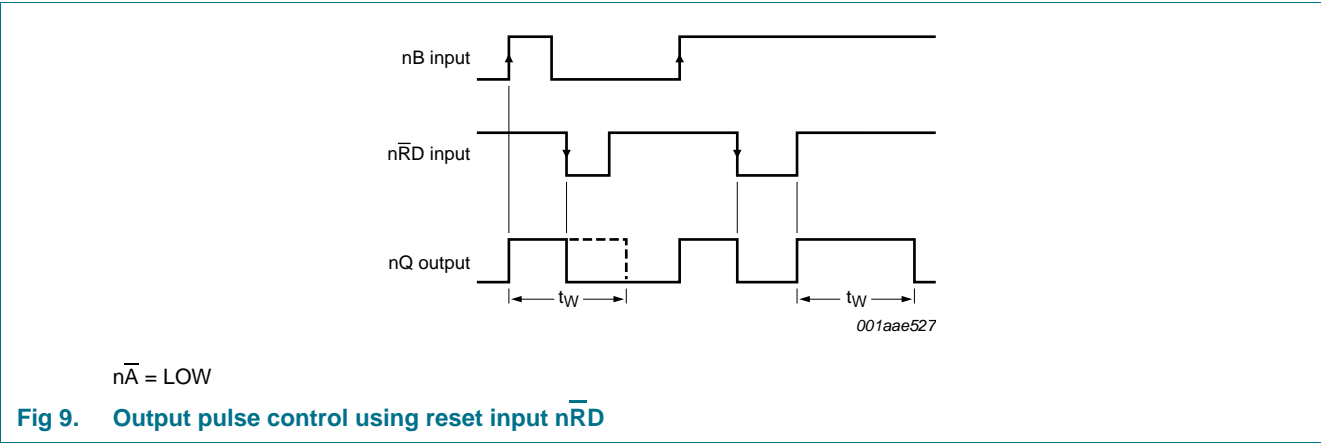


Table 8. Measurement points

| Type | Input | Output |
|-----------------|--------------------|--------------------|
| | V_M | V_M |
| 74AHC123A-Q100 | 0.5V _{CC} | 0.5V _{CC} |
| 74AHCT123A-Q100 | 1.5 V | 0.5V _{CC} |





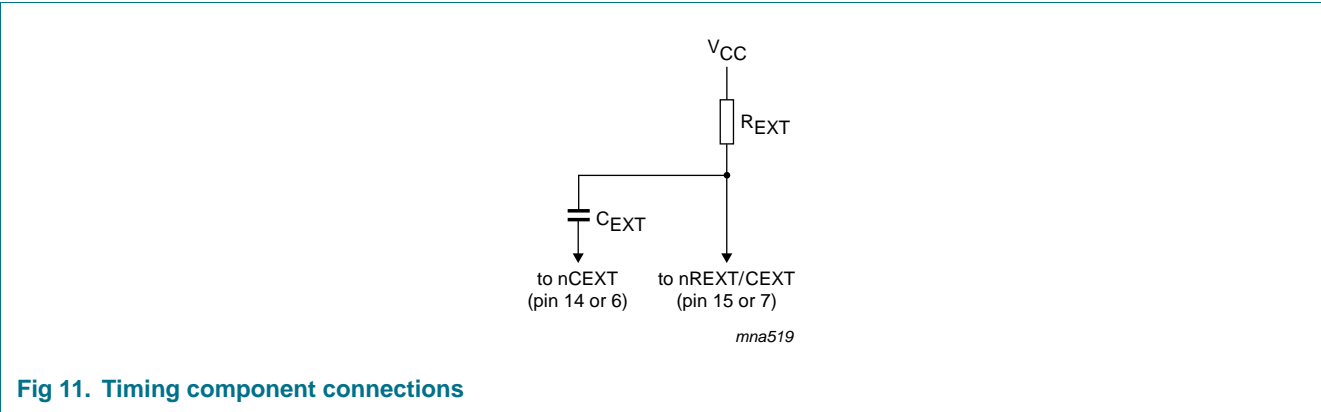


Fig 11. Timing component connections

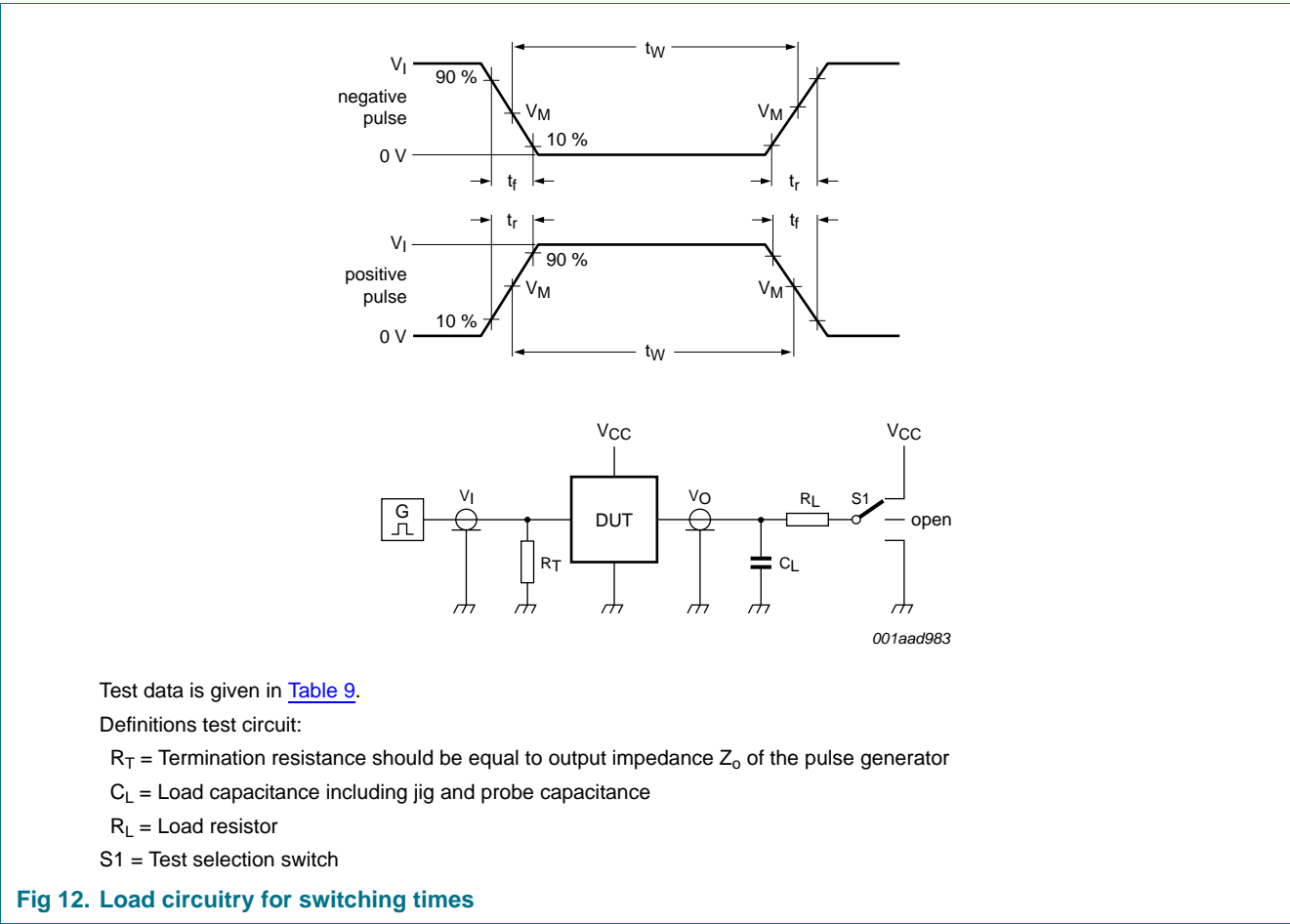


Fig 12. Load circuitry for switching times

| Type | Input | | Load | | S1 position | | |
|-----------------|----------|------------|--------------|--------------|--------------------|--------------------|--------------------|
| | V_I | t_r, t_f | C_L | R_L | t_{PHL}, t_{PLH} | t_{PZH}, t_{PHZ} | t_{PZL}, t_{PLZ} |
| 74AHC123A-Q100 | V_{CC} | 3.0 ns | 15 pF, 50 pF | 1 k Ω | open | GND | V_{CC} |
| 74AHCT123A-Q100 | 3.0 V | 3.0 ns | 15 pF, 50 pF | 1 k Ω | open | GND | V_{CC} |

12. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1

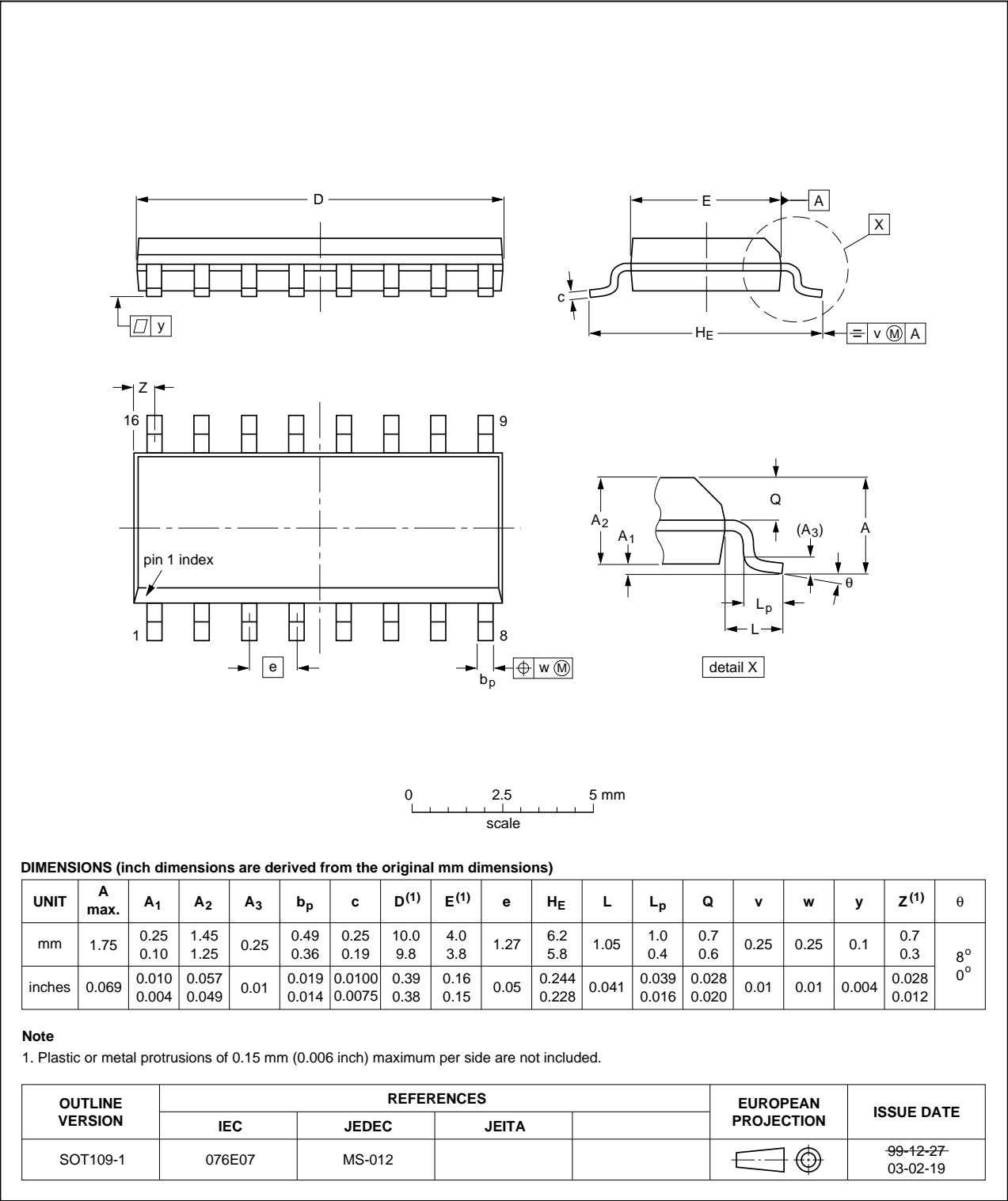


Fig 13. Package outline SOT109-1 (SO16)

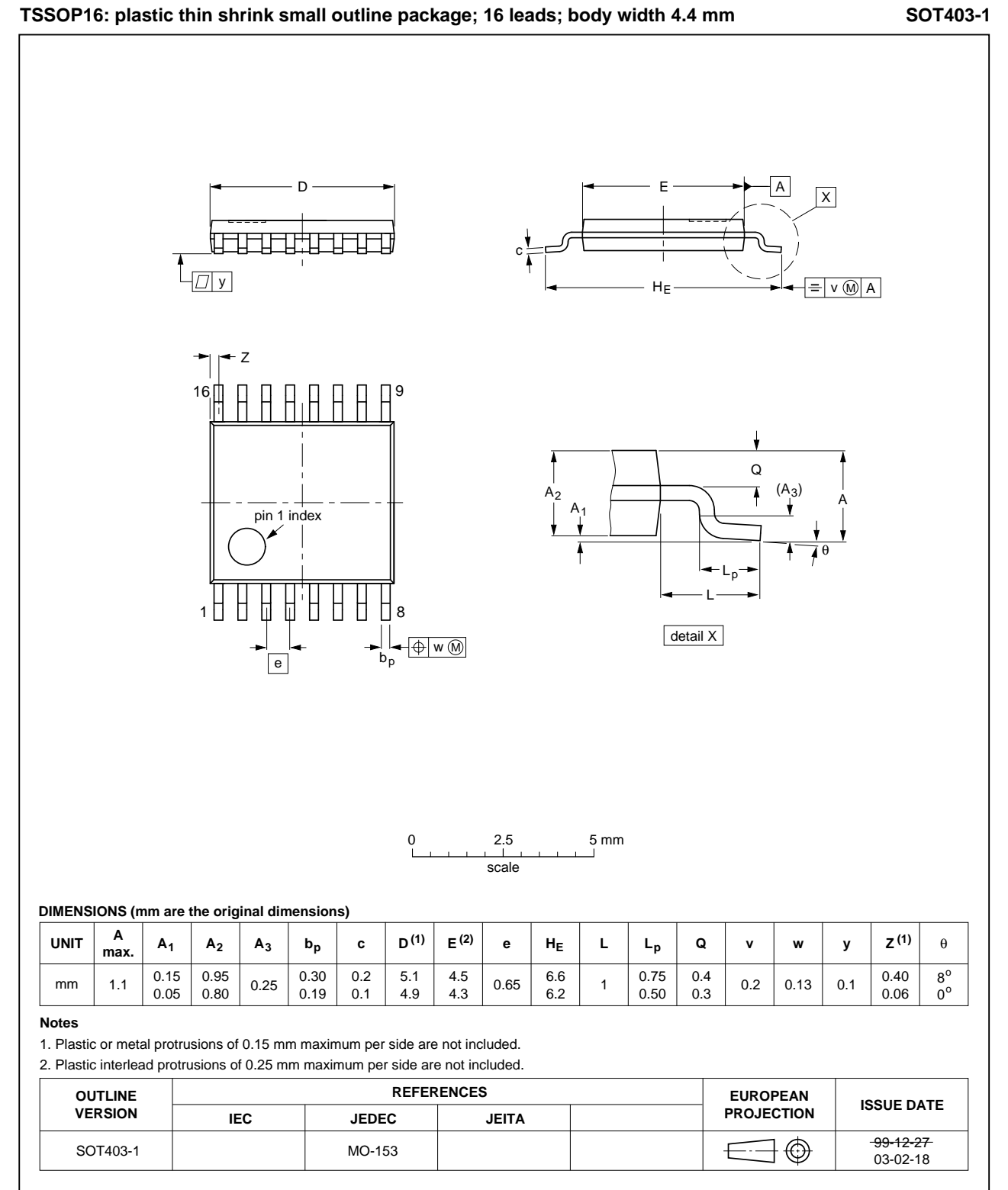


Fig 14. Package outline SOT403-1 (TSSOP16)

DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm

SOT763-1

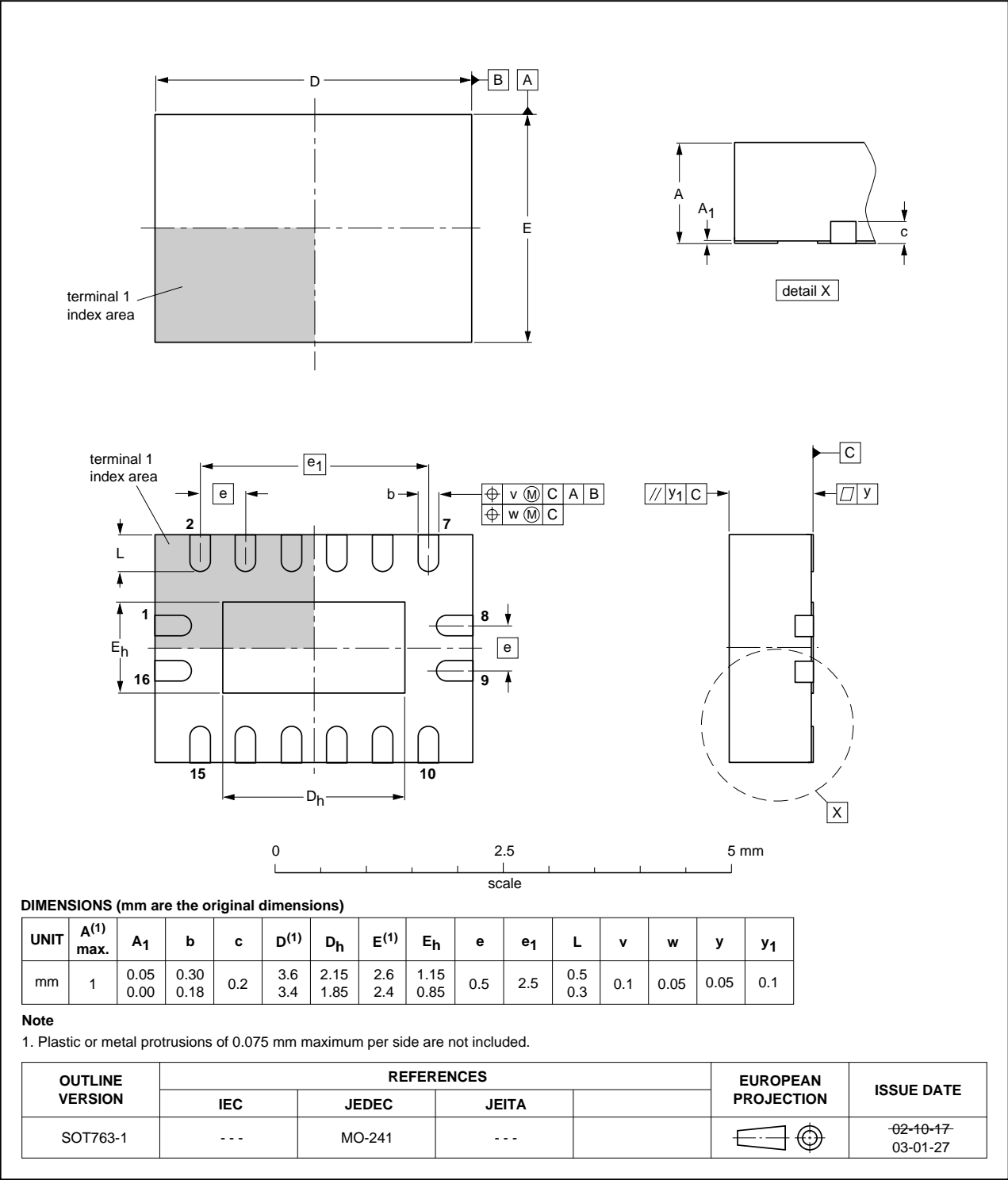


Fig 15. Package outline SOT763-1 (DHVQFN16)

13. Abbreviations

Table 10. Abbreviations

| Acronym | Description |
|---------|--|
| CDM | Charge Device Model |
| CMOS | Complementary Metal-Oxide Semiconductor |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| HBM | Human Body Model |
| LSTTL | Low-power Schottky Transistor-Transistor Logic |
| MIL | Military |
| MM | Machine Model |
| TTL | Transistor-Transistor Logic |

14. Revision history

Table 11. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|-------------------------|--------------|--------------------|---------------|------------|
| 74AHC_AHCT123A_Q100 v.1 | 20130523 | Product data sheet | - | - |

15. Legal information

15.1 Data sheet status

| Document status ^{[1][2]} | Product status ^[3] | Definition |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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